

SPN7002

DESCRIPTION

The SPN7002 is the N-Channel enhancement mode field effect transistors are produced using high cell density DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 300mA DC and can deliver pulsed currents up to 1.0A. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

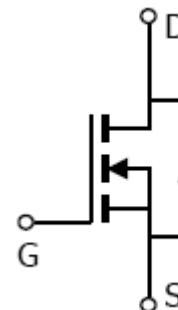
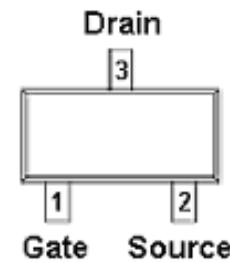
APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- High saturation current capability. Direct Logic-Level Interface: TTL/CMOS
- Battery Operated Systems
- Solid-State Relays

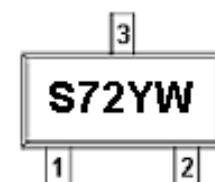
FEATURES

- ◆ 60V/0.50A , R_{DS(ON)}= 6.0Ω@V_{GS}=10V
- ◆ 60V/0.30A , R_{DS(ON)}= 7.0Ω@V_{GS}=5V
- ◆ Super high density cell design for extremely low R_{DS (ON)}
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23 and SOT-323 package design

PIN CONFIGURATION(SOT-23 , SOT-323)



PART MARKING



Y : Year Code
W : Week Code

**SPN7002****PIN DESCRIPTION**

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN7002S23RG	SOT-23	S72YW
SPN7002S23RGB	SOT-23	S72YW
SPN7002S32RG	SOT-323	S72YW
SPN7002S32RGB	SOT-323	S72YW

- ※ Week Code : A ~ Z(1 ~ 26) ; a ~ z(27 ~ 52)
- ※ SPN7002S23RG : Tape Reel ; Pb – Free
- ※ SPN7002S23RGB : Tape Reel ; Pb – Free; Halogen – Free
- ※ SPN7002S32RG : Tape Reel ; Pb – Free
- ※ SPN7002S32RGB : Tape Reel ; Pb – Free; Halogen – Free

ABSOULTE MAXIMUM RATINGS (TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate –Source Voltage - Continuous	V _{GSS}	±20	V
Gate –Source Voltage - Non Repetitive (t _p < 50μs)	V _{GSS}	±40	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	I _D	A
Pulsed Drain Current (*)	I _{DM}	1.0	A
Power Dissipation	T _A =25°C	P _D	W
Operating Junction Temperature	T _J	-55 ~ 150	°C
Storage Temperature Range	T _{STG}	-55 ~ 150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	375	°C/W

(*) Pulse width limited by safe operating area



ELECTRICAL CHARACTERISTICS (TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=250uA	60			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=250uA	1.0	1.7	2.5	
Gate Leakage Current	IGSS	VDS=0V, VGS=±20V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=48V, VGS=0V			1	uA
		VDS=48V, VGS=0V TJ=55°C			10	
Drain-Source On-Resistance	RDS(on)	VGS=10V, ID=0.50A		2.5	6.0	Ω
		VGS= 5V, ID=0.30A		3.3	7.0	
Source-drain Current	ISD				0.35	A
Source-drain Current (pulsed)	ISDM (2)				1.4	A
Forward Transconductance	Gfs(1)	VDS = 10 V, ID = 0.5 A		0.6		S
Diode Forward Voltage	VSD(1)	VGS = 0 V, Is = 0.12A		0.85	1.5	V
Dynamic						
Total Gate Charge	Qg	VDD = 30 V, ID = 1 A, VGS = 5 V		1.4	2.0	nC
Gate-Source Charge	Qgs			0.8		
Gate-Drain Charge	Qgd			0.5		
Input Capacitance	Ciss	VDS = 25 V, f = 1 MHz, VGS = 0		43	60	pF
Output Capacitance	Coss			20	30	
Reverse Transfer Capacitance	Crss			6	10	
Turn-On Time	td(on)	VDD = 30 V, ID = 0.5 A RG = 4.7Ω VGS = 4.5 V		5	20	ns
	tr			15		
Turn-Off Time	td(off)			7	20	
	tf			8		

(1) Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.

(2) Pulse width limited by safe operating area.